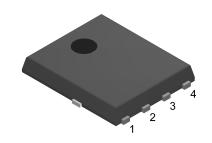
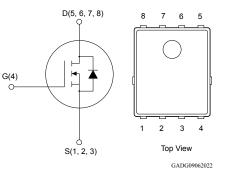


N-channel 40 V, 2.6 m Ω max., 154 A STripFET F8 Power MOSFET in a PowerFLAT 5x6 package



PowerFLAT 5x6



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STL160N4F8	40 V	2.6 mΩ	154 A

- MSL1 grade
- 175 °C maximum operating junction temperature
- 100% avalanche tested
- Low gate charge Q_q

Applications

- Industrial tools, motor drives and equipment
- Power supplies and converters
- Home and professional appliances

Description

The STL160N4F8 is a 40 V N-channel enhancement mode Power MOSFET designed in STripFET F8 technology featuring an enhanced trench gate structure.

It ensures a state-of-the-art of figure of merit for very low on-state resistance while reducing internal capacitances and gate charge for faster and more efficient switching.





Product status link STL160N4F8

Product summary				
Order code STL160N4F8				
Marking ⁽¹⁾	160N4F8			
Package	PowerFLAT 5x6			
Packing	Tape and reel			

 Engineering samples are clearly identified with a dedicated special symbol in the marking of each unit



1 Electrical ratings

Table 1. Absolute maximum ratings (at T_C = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	±20	V
	Drain current (continuous) at T _C = 25 °C ⁽²⁾	154	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C ⁽²⁾	109	Α
	Drain current (continuous) at T _C = 25 °C ⁽³⁾	120	
I _{DM} ⁽¹⁾⁽²⁾⁽⁴⁾	Drain current (pulsed), t _P = 10 μs	615	Α
P _{TOT}	Total power dissipation at T _C = 25 °C	111	W
I _{AS}	Single pulse avalanche current (pulse width limited by maximum junction temperature)	60	Α
E _{AS}	Single pulse avalanche energy (starting T_J = 25 °C, I_D = 60 A, R_{Gmin} = 25 Ω)	151	mJ
TJ	Operating junction temperature range	-55 to 175	°C
T _{stg}	Storage temperature range	-55 (0 175	°C

- 1. Specified by design, not tested in production.
- 2. This is the theoretical current value only related to the silicon.
- 3. This current value is limited by package.
- 4. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA} ⁽¹⁾	Thermal resistance, junction-to-ambient (on 2s2p FR-4 board vertical in still area)	16.9	°C/W
R _{thJC}	Thermal resistance, junction-to-case	1.35	°C/W

1. Defined according to JEDEC standards (JESD51-5, -7).

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2 Electrical characteristics

 T_J = 25 °C unless otherwise specified.

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 1 mA	40			V
		V _{DS} = 40 V, V _{GS} = 0 V			1	
$I_{\rm DSS}$	Zero gate voltage drain current	V _{DS} = 40 V, V _{GS} = 0 V,			100	μA
		T _J = 125°C			100	
I _{GSS}	Gate-body leakage current	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source	V _{GS} = 10 V, I _D = 60 A		2.1	2.6	mΩ
1 (03(011)	on-resistance	VGS 10 1, 10 00 / 1		2.1	2.0	11122
$R_{G}^{(1)}$	Gate resistance				1.2	Ω

^{1.} Specified by design and evaluated by characterization, not tested in production.

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} (1)	Input capacitance			2400	-	pF
C _{oss} (1)	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	690	-	pF
C _{rss} (1)	Reverse transfer capacitance			18	-	pF
Q _g (1)	Total gate charge	V_{DD} = 20 V, I_{D} = 60 A, V_{GS} = 0 to 10 V		28	-	nC
Q _{gs} (1)	Gate-source charge			13	-	nC
Q _{gd} (1)	Gate-drain charge			3	-	nC
Q _{g(sync)}	Total gate charge, sync. MOSFET	V _{DS} = 0.1 V, V _{GS} = 0 to 10 V	-	28	-	nC
Q _{oss}	Output charge	V _{DD} = 20 V, V _{GS} = 0 V	-	37.3	-	nC

^{1.} Specified by design and evaluated by characterization, not tested in production.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} (1)	Turn-on delay time	V_{DD} = 20 V, I_{D} = 60 A, R_{G} = 4.7 Ω , V_{GS} = 10 V	-	12	-	ns
t _r (1)	Rise time		-	2.6	-	ns
t _{d(off)} (1)	Turn-off delay time		-	16	-	ns
t _f (1)	Fall time		-	3.5	-	ns

^{1.} Specified by design and evaluated by characterization, not tested in production.

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Table 6. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ^{(1) (2)}	Forward on current (continuous)	T _C = 25 °C	-		80	А
V _{SD}	Forward on voltage	I _{SD} = 60 A, V _{GS} = 0 V	-		1.1	V
t _{rr} (1)	Reverse recovery time		-	41		ns
Q _{rr} ⁽¹⁾	Reverse recovery charge	$I_D = 60 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, V_{DD} = 32 \text{ V}$	-	1.7		nC
I _{RRM} ⁽¹⁾	Reverse recovery current		-	35		Α

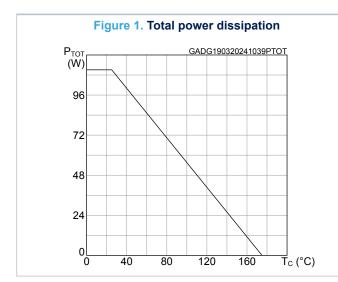
^{1.} Specified by design and evaluated by characterization, not tested in production.

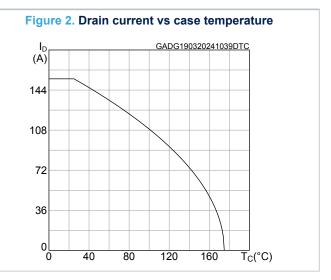
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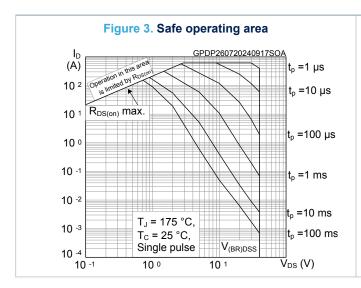
^{2.} This is the theoretical current value only related to the silicon.

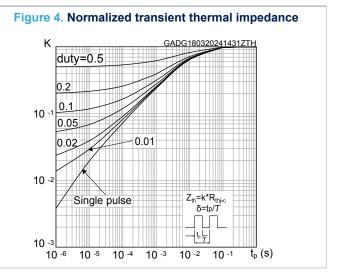


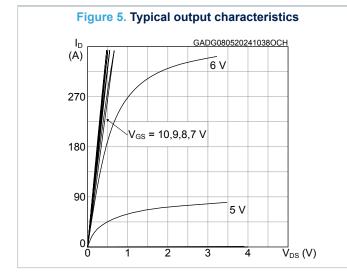
2.1 Electrical characteristics (curves)

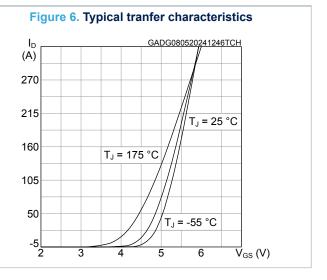












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Figure 7. Typical gate charge characteristics

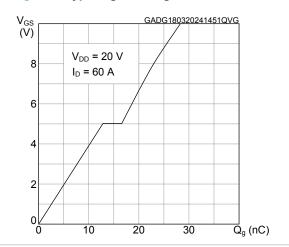


Figure 8. Typical capacitance characteristics

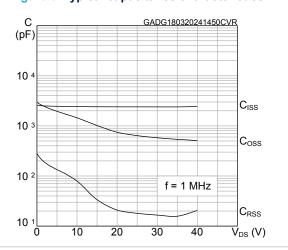


Figure 9. Avalanche characteristics

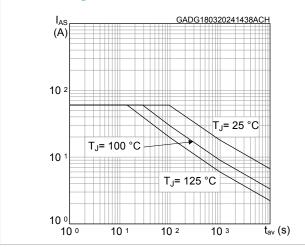


Figure 10. Avalanche energy

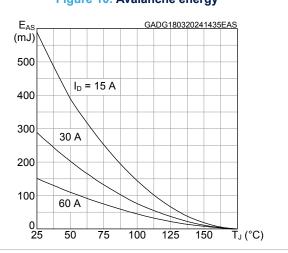


Figure 11. Typical drain-source on-resistance

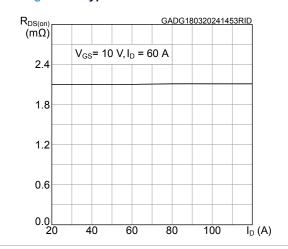
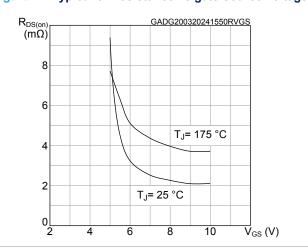


Figure 12. Typical on-resistance vs gate-source voltage



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Figure 13. Normalized on-resistance vs temperature

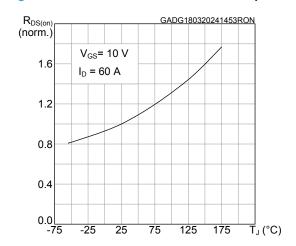


Figure 14. Normalized gate threshold voltage vs temperature

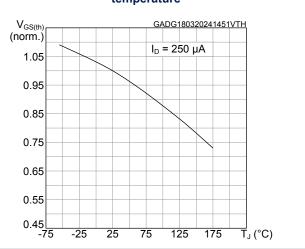


Figure 15. Typical reverse diode forward characteristics

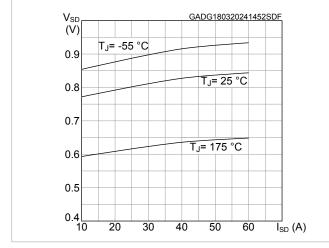
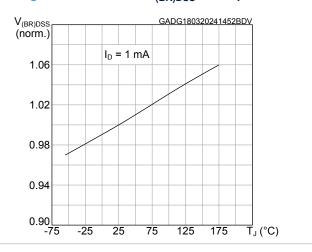


Figure 16. Normalized $V_{(BR)DSS}$ vs temperature



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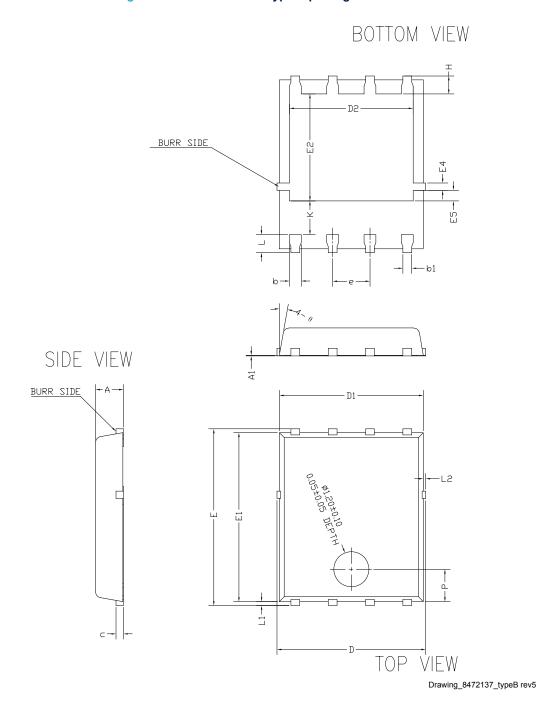


3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

3.1 PowerFLAT 5x6 type B package information

Figure 17. PowerFLAT 5x6 type B package outline



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Table 7. PowerFLAT 5x6 type B mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	0.90	0.95	1.00
A1		0.02	
b	0.35	0.40	0.45
b1		0.30	
С	0.21	0.25	0.34
D	4.80		5.10
D1	4.80	4.90	5.00
D2	4.01	4.21	4.31
е	1.17	1.27	1.37
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.54	3.64	3.74
E4	0.15	0.25	0.35
E5	0.26	0.36	0.46
Н	0.51	0.61	0.71
K	0.95		
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
L2			0.10
Р	1.00	1.10	1.20
θ	8°	10°	12°

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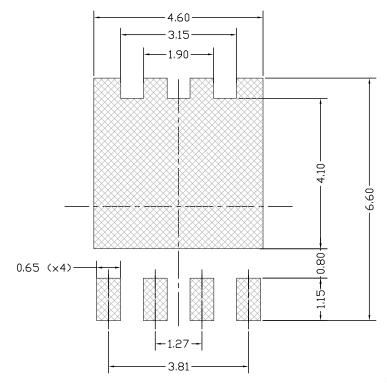
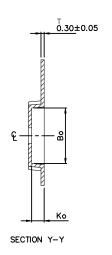


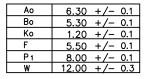
Figure 18. PowerFLAT 5x6 recommended footprint (dimensions are in mm)

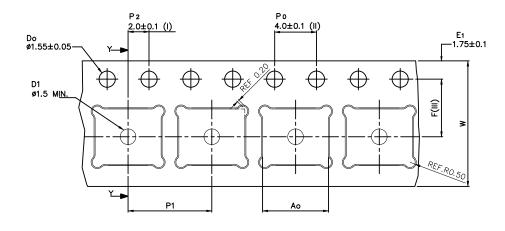
Footprint_8472137_typeB rev5

3.2 PowerFLAT 5x6 packing information

Figure 19. PowerFLAT 5x6 tape (dimensions are in mm)







(I) Measured from centreline of sprocket hole to centreline of pocket.

(II) Cumulative tolerance of 10 sprocket holes is ±0.20.

(III) Measured from centreline of sprocket hole to centreline of pocket

Base and bulk quantity 3000 pcs All dimensions are in millimeters

8234350_Tape_rev_C

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Figure 20. PowerFLAT 5x6 package orientation in carrier tape

Pin 1 identification

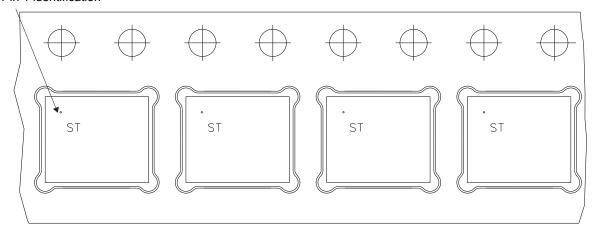
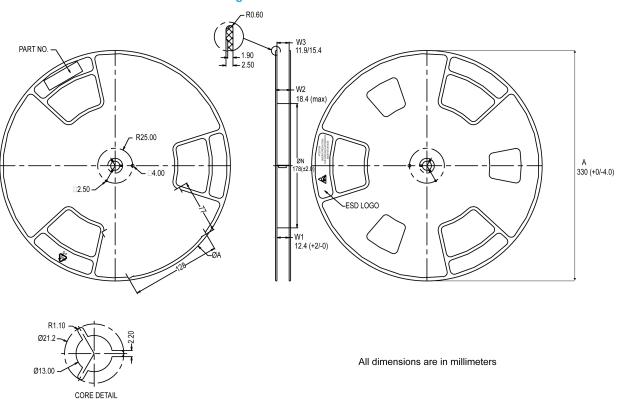


Figure 21. PowerFLAT 5x6 reel



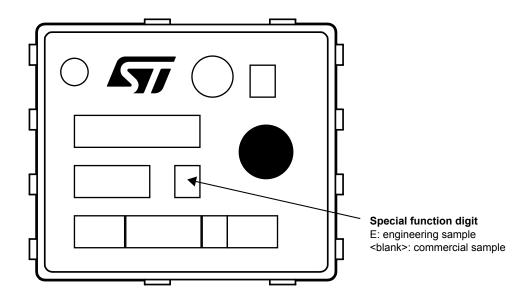
8234350_Reel_rev_C

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3.3 PowerFLAT 5x6 marking information

Figure 22. PowerFLAT 5x6 marking information



Note:

Engineering Samples: these samples can be clearly identified by a dedicated special symbol in the marking of each unit. These samples are intended to be used for electrical compatibility evaluation only; usage for any other purpose may be agreed only upon written authorization by ST. ST is not liable for any customer usage in production and/or in reliability qualification trials.

Commercial Samples: fully qualified parts from ST standard production with no usage restrictions.

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Revision history

Table 8. Document revision history

Date	Revision	Changes
15-May-2024	1	First release.
26-Jul-2024	2	Updated Figure 3. Safe operating area.

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